orm 1°TO-1595 (Rev. 09/ 04) DMB No. 0651-0027 (exp. 6/30/2005)	U.S. DEPARTMENT OF COMMERC United States Patent and Trademark Office
RECORDATION FOR	
PATENTS ONLY	
To the Director of the U.S. Patent and Trademark Office: Please	record the attached documents or the new address(es) below.
Name of conveying party(les)/Execution Date(s):	2. Name and address of receiving party(les)
YOSUKE KIMOTO (07/11/2002) AND	
KAZUHIRO KANEE (07/11/2002)	SONY COMPUTER
	Name: ENTERTAINMENT INC.
	Internal Address:
Execution Date(s): In parentheses after inventor name	Street Address:
Additional name(s) of conveying party(les) attached? Yes X No	
3. Nature of Conveyance:	Tokyo
X Assignment Merger	108-0075 JAPAN
Security Agreement Change of Name	City:
Government Interest Assignment	State:
Executive Order 9424, Confirmatory License	Country:Zip:
Other	Additional name(s) & address(es)
4. Application or patent number(s):	This document is being filed together with a new application.
A. Patent Application No.(s)	B. Patent No.(s)
12/456,452	
Additional numbers attached	Yes X No
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Daryl K. Neff	
LERNER, DAVID, LITTENBERG,	
KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Atty. Dkt.: SCEI 3.0-132 CON	Authorized to be charged by credit card
Street Address: 600 South Avenue West	X Authorized to be charged to deposit account
	Enclosed
	None required (government interest not affecting title)
	Monta raddinad (Boyesi ilitelias interest not alleening the
City Westfield	8, Payment Information
State: NJ Zip: 07090	a, Credit Card Last 4 Numbers
Phone Number: (906) 518-6396	Expiration Date
Fax Number: (908) 654-0415	b. Deposit Account Number 12-1095
Email Address: dneff@ldlkm.com	Authorized User Name Daryl K. Neff
9. Signature:	
	December 14, 2010
Signature	Date
Daryl K. Neff - 38,253 Name of Person Signing	Total number of pages including cover sheet, attachments, and documents: 3
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PATENT REEL: 025585 FRAME: 0799 LDLKM

SCEI Ref. No.: SC02019US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

LOG COLLECTING/ANALYZING SYSTEM WITH SEPARATED FUNCTIONS OF COLLECTING LOG INFORMATION AND ANALYZING THE SAME

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 1-1, Akasaka 7-chome, Minato-ku, Tokyo 107-0052, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 10/162,470, Filing Date: June 4, 2002.

This assignment executed on the dates indicated below.

Yousuke Kimoto Name of First or Sole Inventor	Execution Date of U.S. Patent Application
Canagawa Japan	
Residence of First or Sole Inventor	July 11, 2002
Yousuke Lime to Signature of First or Sole Inventor	Date of this Assignment

PATENT REEL: 025585 FRAME: 0800

SCEI Ref. No.: SC02019US00

Kazuhiro Kanee	
Name of Second Joint Inventor	Execution Date of U.S. Patent Application
Tokyo Japan Residence of Second Joint Inventor	
Residence of Second Joint Inventor	(MC NIM)
Kazuhiro Kanee	July 11, 2002 Date of this Assignment
Signature of Second Joint Inventor	Date of this Assignment
Name of Third Joint Inventor	Execution Date of U.S. Patent Application
Residence of Third Joint Inventor	
Signature of Third Joint Inventor	Date of this Assignment
Name of Fourth Joint Inventor	Execution Date of U.S. Patent Application
Residence of Fourth Joint Inventor	
Signature of Fourth Joint Inventor	Date of this Assignment
Name of Fifth Joint Inventor	Execution Date of U.S. Patent Application
Residence of Fifth Joint Inventor	
Signature of Fifth Joint Inventor	Date of this Assignment

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PATENT REEL: 025585 FRAME: 0801